

# 动态相位偏折法三维量检技术

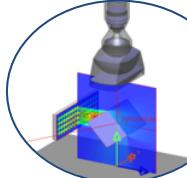
## Dynamic Deflectometry for Defect Inspection

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香港应用科技研究院

### 基于动态相位偏折技术的3D缺陷检测系统

3D defect inspection system based on dynamic phase deflection technology

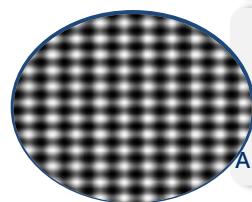
(适用于高速、高精度运动产线反光表面)



#### 共轴远心线扫感知系统

Coaxial telecentric line scanning

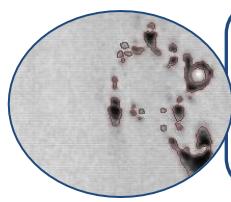
- 动态相位偏折术的感测头  
Dynamic phase measuring Deflectometry



#### 多频空间载波偏折术

Hybrid-frequency Spatial-carrier Deflectometry

- 动态线扫相位偏折术恢复表面形貌  
A Newly Proposed Method for Specular Surface 3D Sensing



#### 频率引导梯度场缺陷检测

Frequency Guided Defect Inspection

- 多频融合梯度场快速3D缺陷检测  
Fast 3D Defect Inspection method

### 真空磁控溅射镀膜技术面临的问题：

Problems faced by vacuum magnetron sputtering coating technology

- 产线的高缺陷率

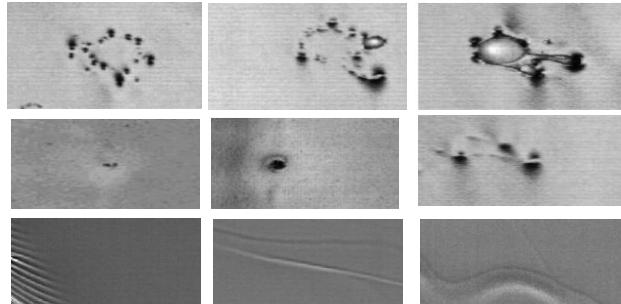
High defect rate on the production line

- 生产效率(~50米/分钟)要求高速检测技术配合

Production efficiency (~50 meters/minute) requires the high-speed detection technology

- 被检金属膜幅面大(~1.6m宽) · 缺陷尺寸小(~微米) · 缺陷形态复杂

Large wide(~1.6m), Small defect size (~microns), Complex defect shapes.



### 应用场景 Application Scenarios

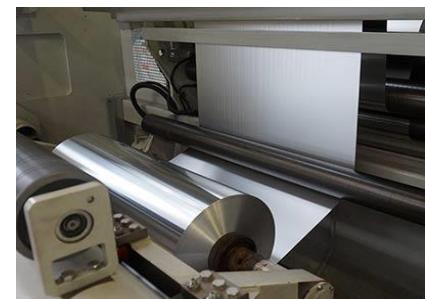
#### 碳化硅缺陷检测

Silicon carbide defect inspection



#### 金属箔片3D缺陷检测

3D defect detection of metal foil



#### 检测难点包括 Technical challenges :

- 反光表面的成像难度大  
Reflective surfaces are difficult to image
- 难以针对大视场场景做到高速、高分辨率成像  
Difficult to achieve high-speed and high-resolution imaging for large FOV
- 难以做到实时缺陷检测  
Real-time defect detection is difficult to achieve

### 应科学院检测系统规格 System Specification

缺陷尺寸 Defect size	30μm(高) 30μm(Height)
分辨率 Resolution	X: 20μm; Y: 20μm; Z: 10μm
视场FOV	240mm
检测速度 Inspection speed	80K线/s 80K lines/s
缺陷种类 Defect type	飞溅点、凹凸点、褶皱... Splatter, bulge and dent , wrinkling